



FIG. 1

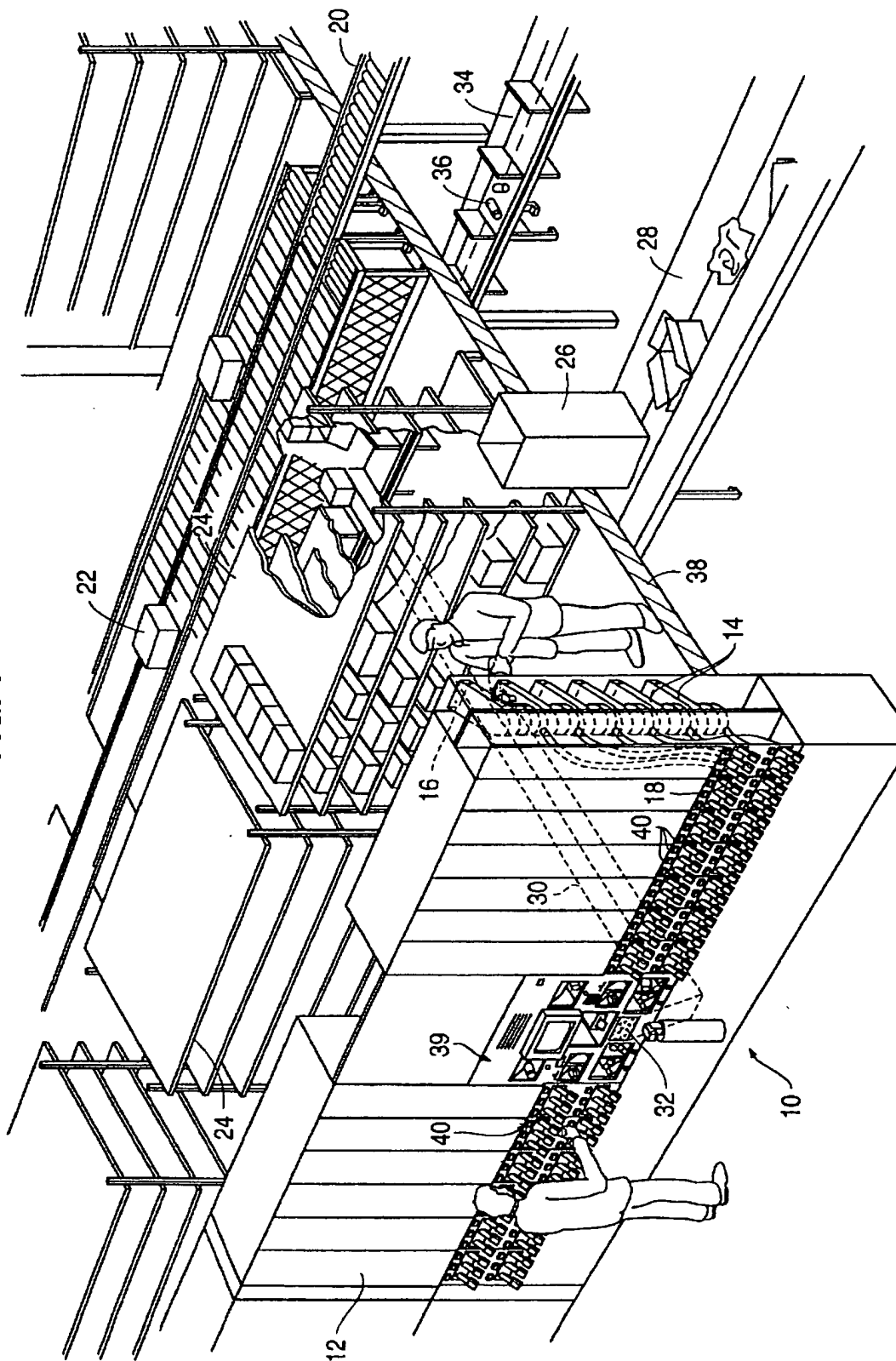




FIG. 2

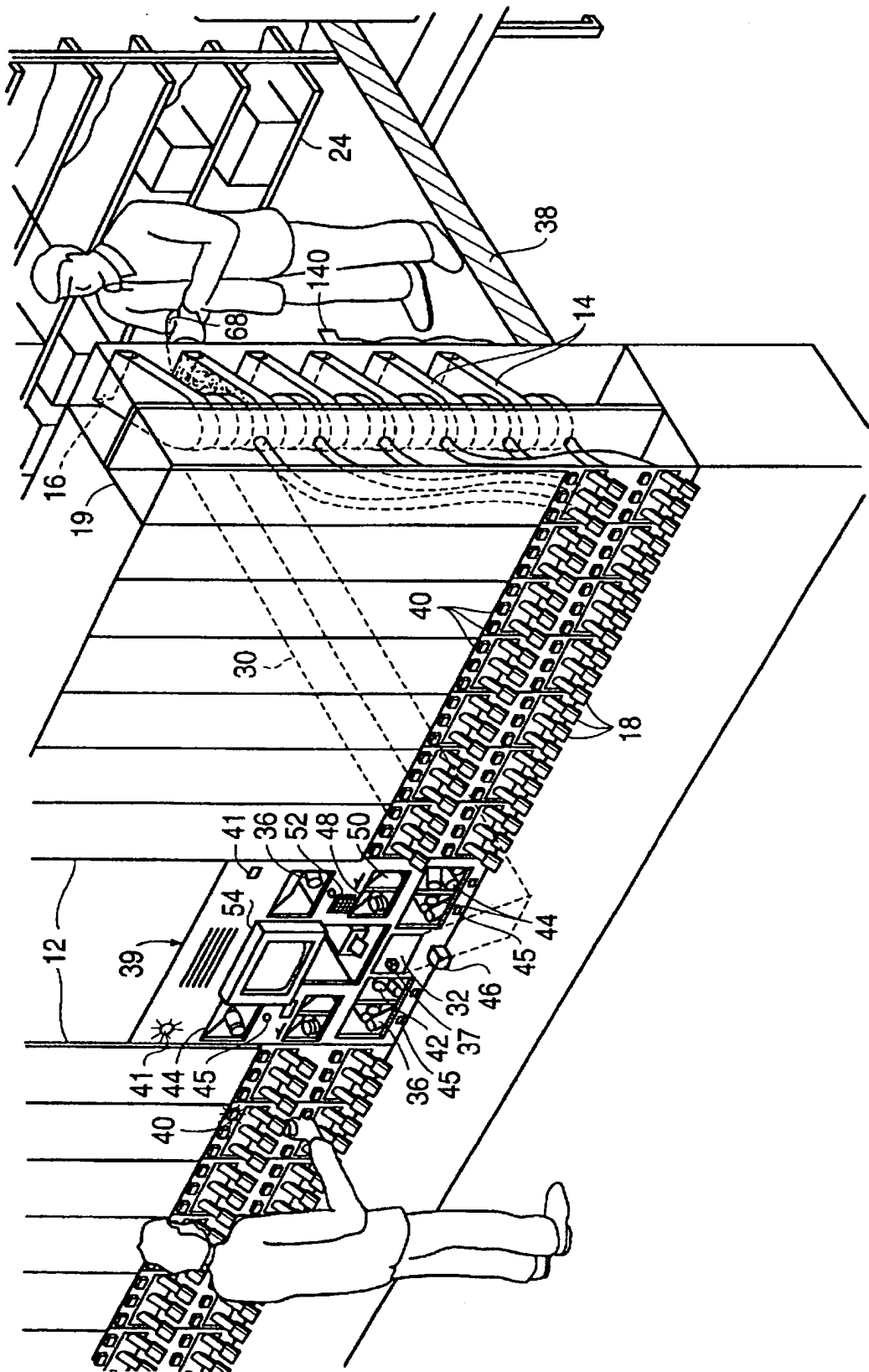


FIG. 3

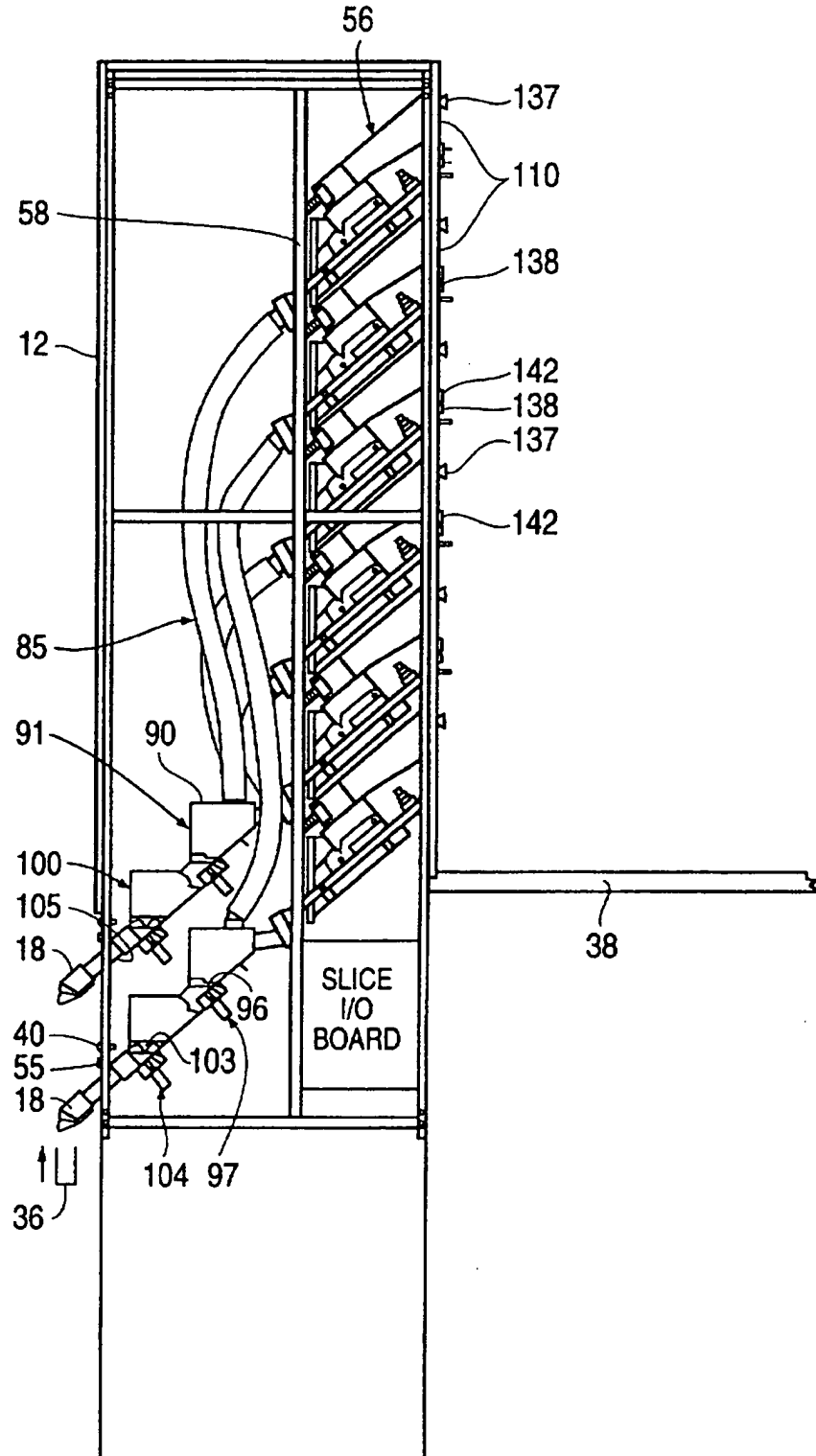




FIG. 4

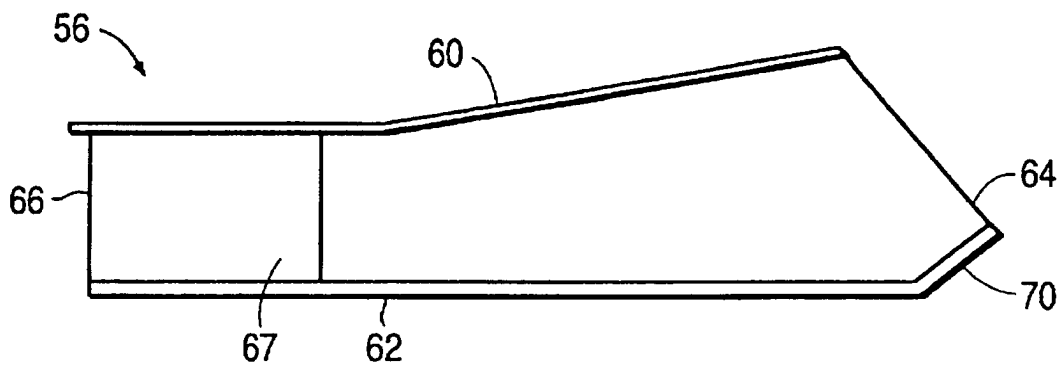


FIG. 5

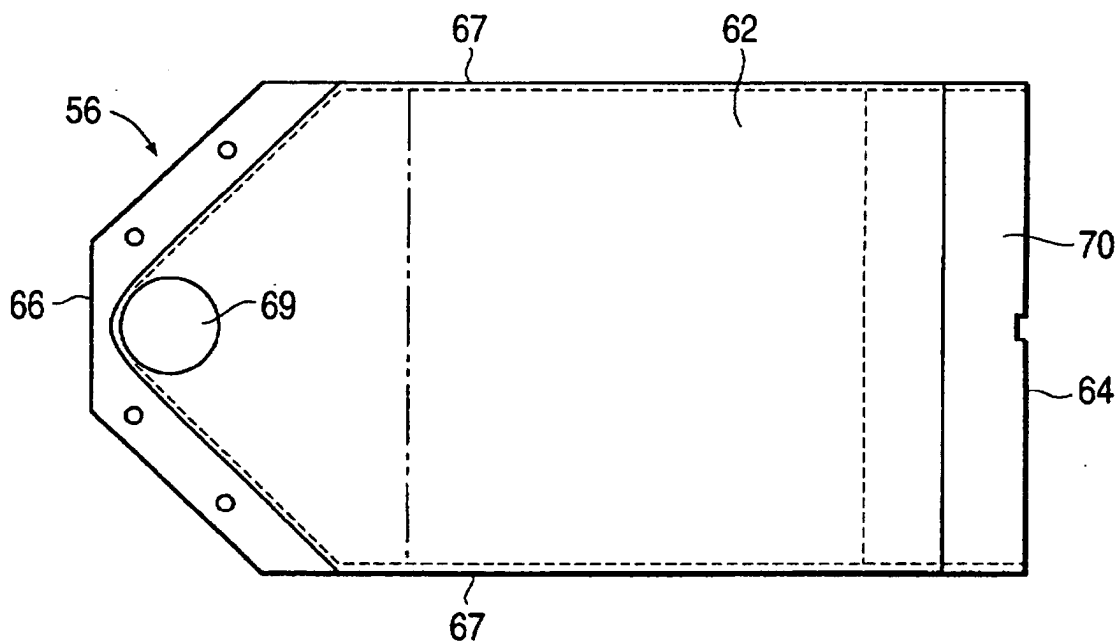


FIG. 6

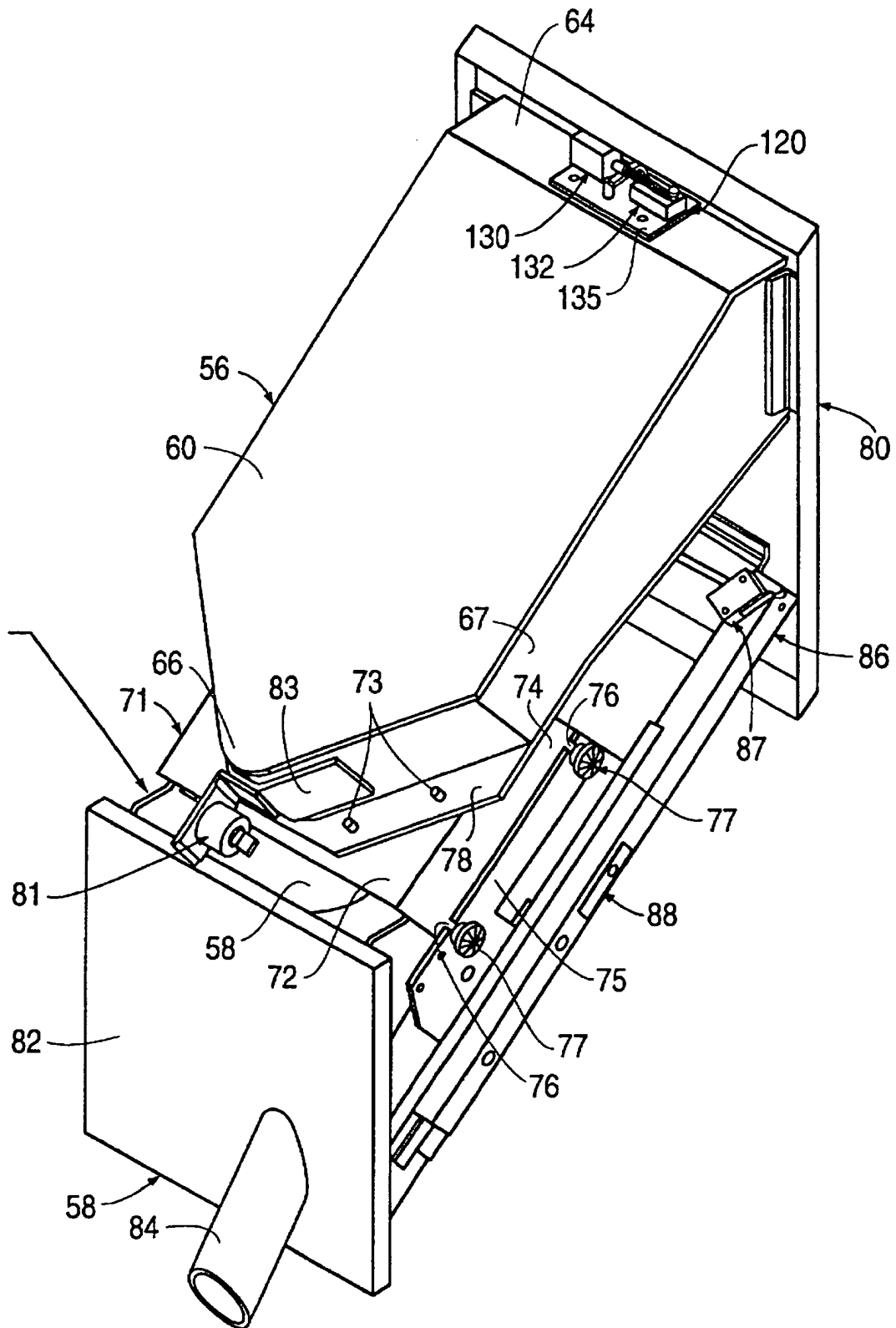


FIG. 7

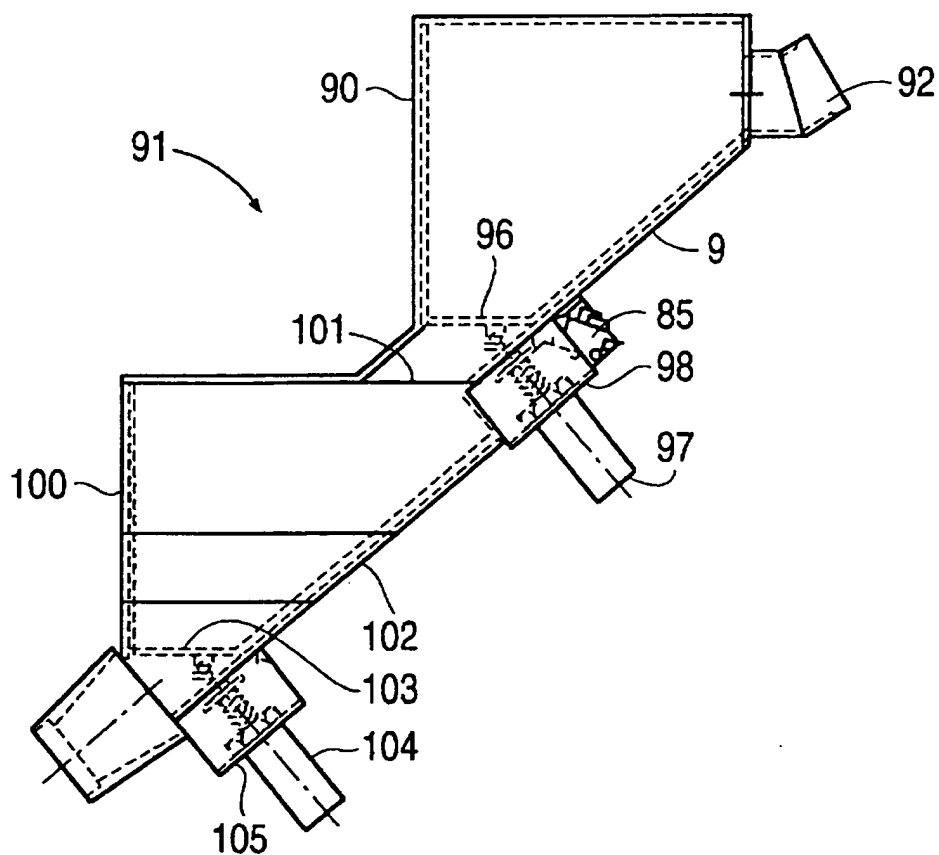


FIG. 8

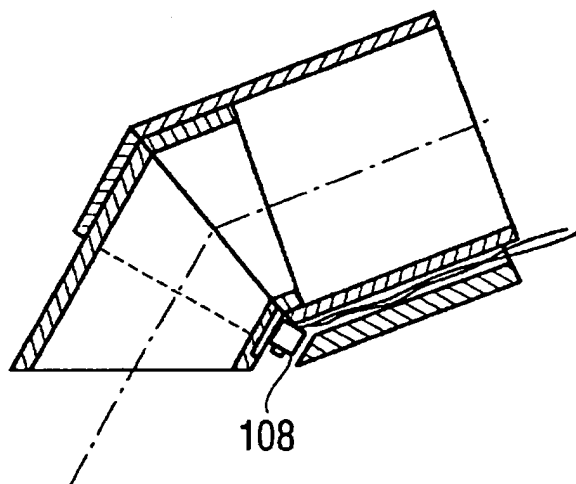




FIG. 9

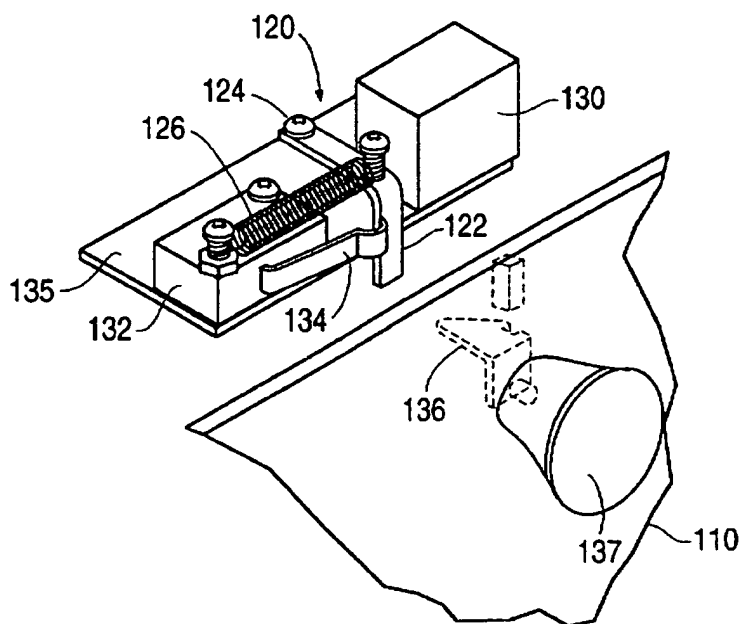


FIG. 10

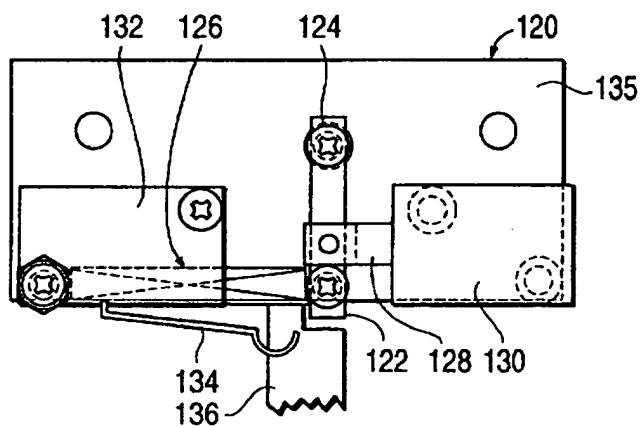


FIG. 11

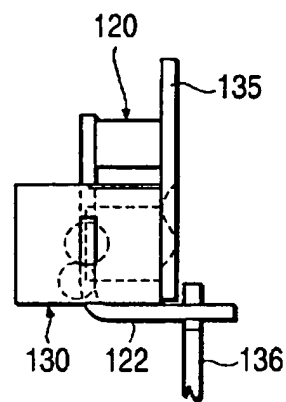


FIG. 12

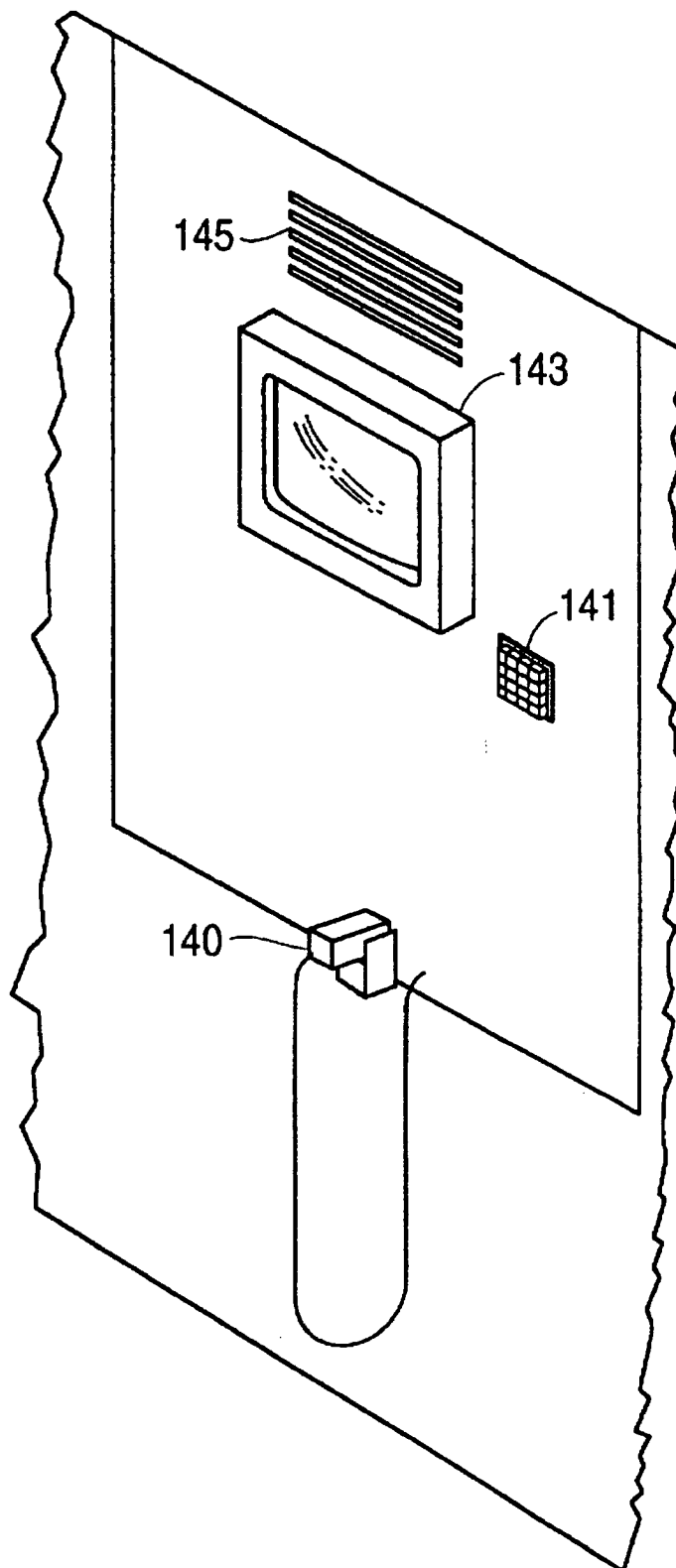




FIG. 13

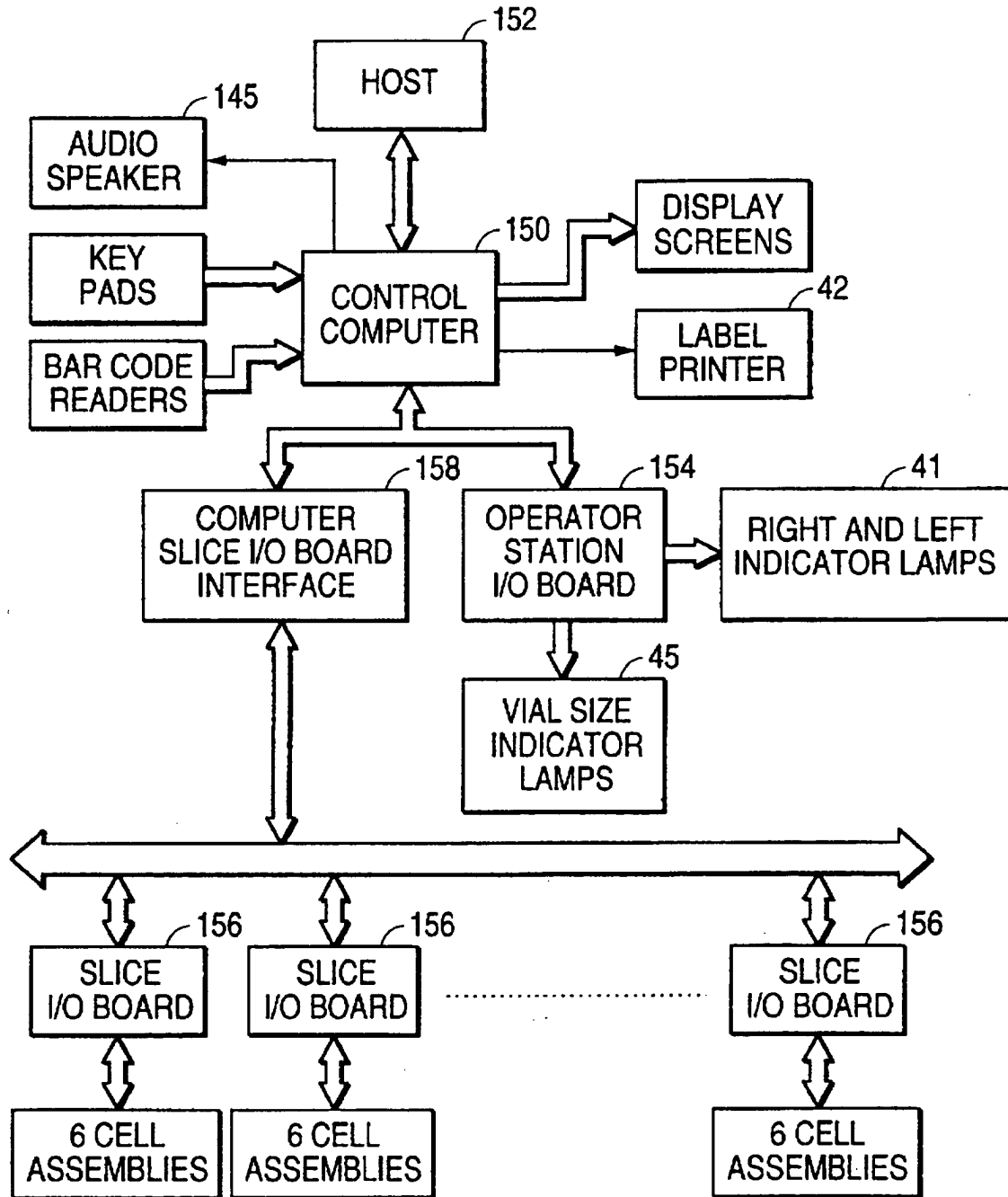
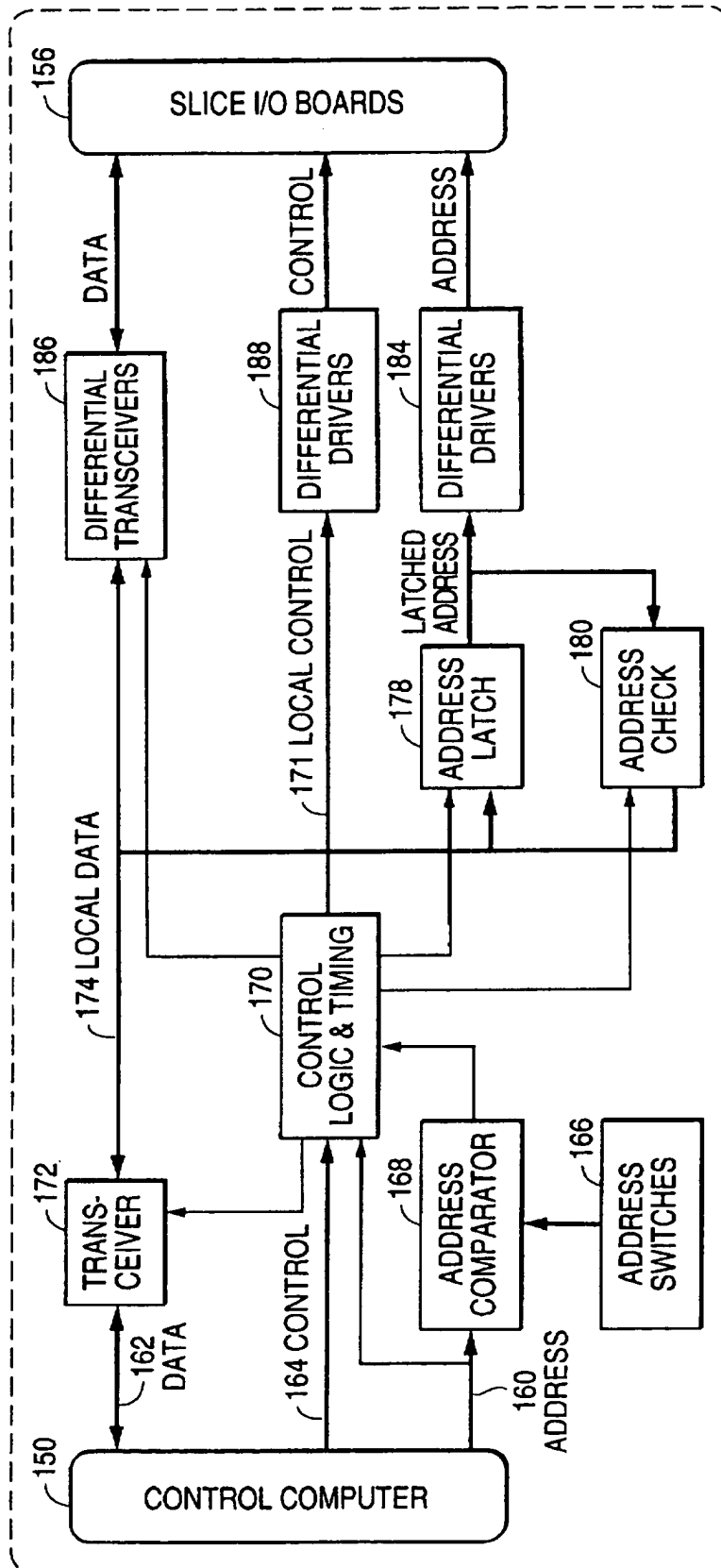


FIG. 14



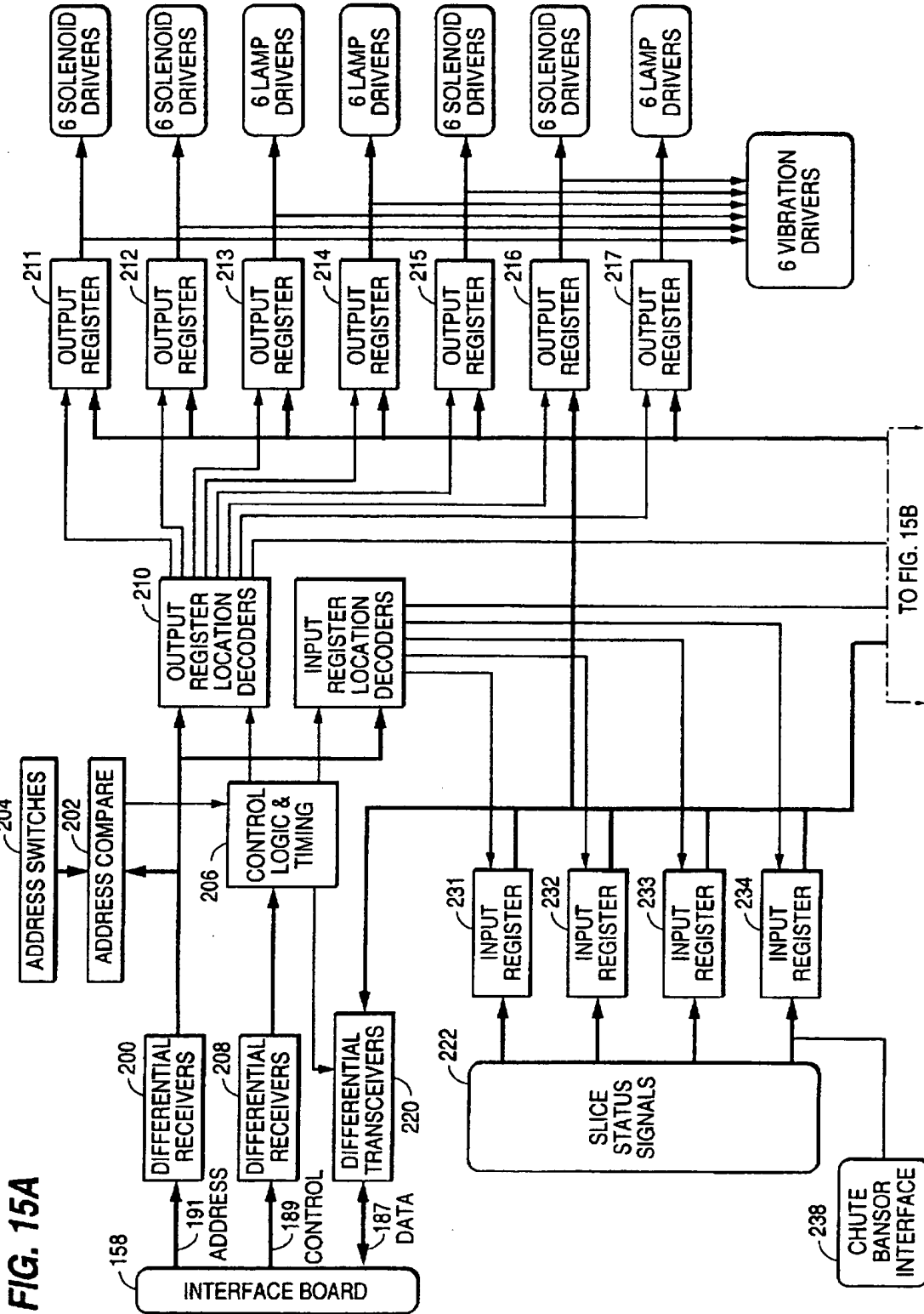


FIG. 15B

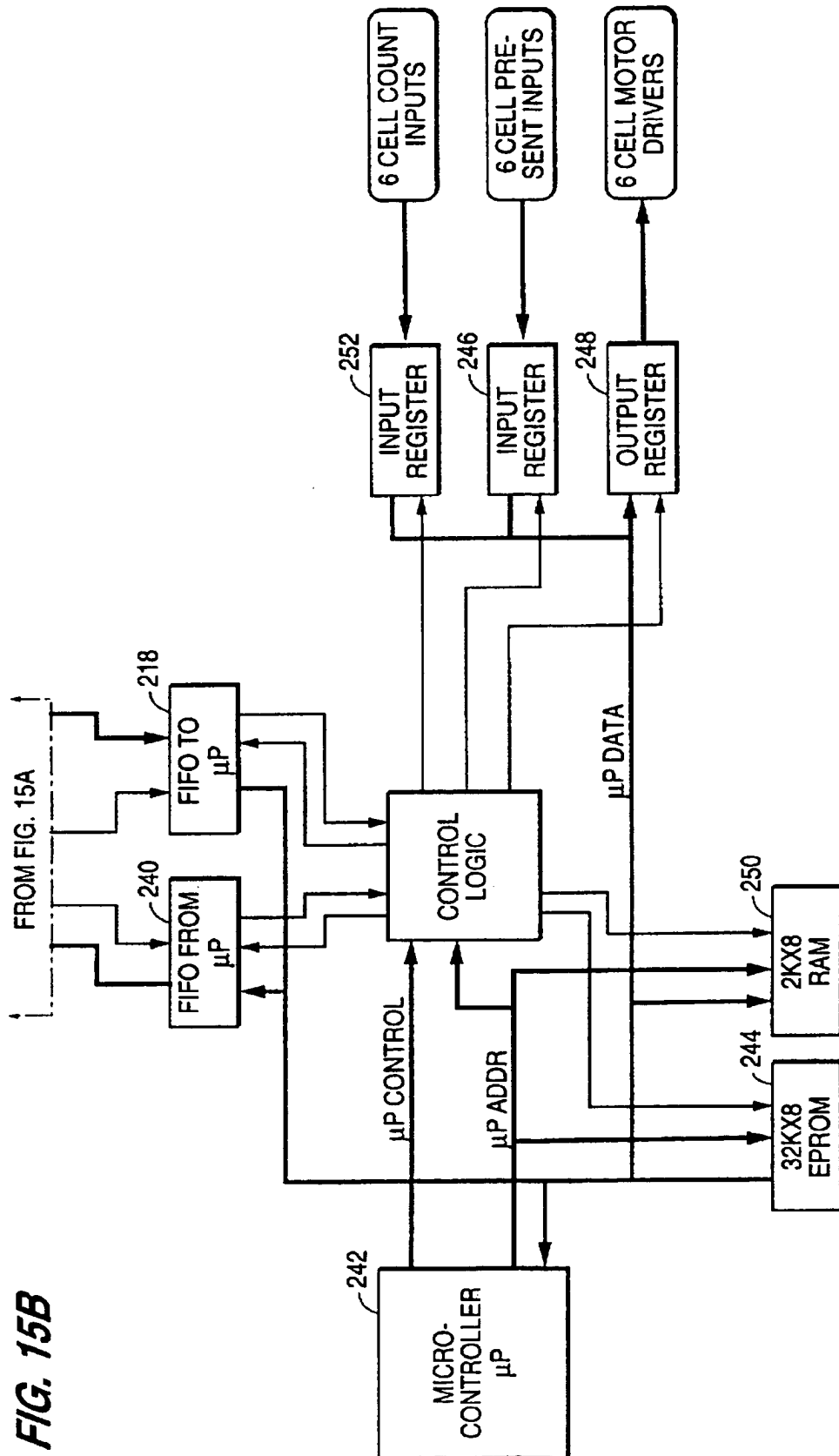


FIG. 16

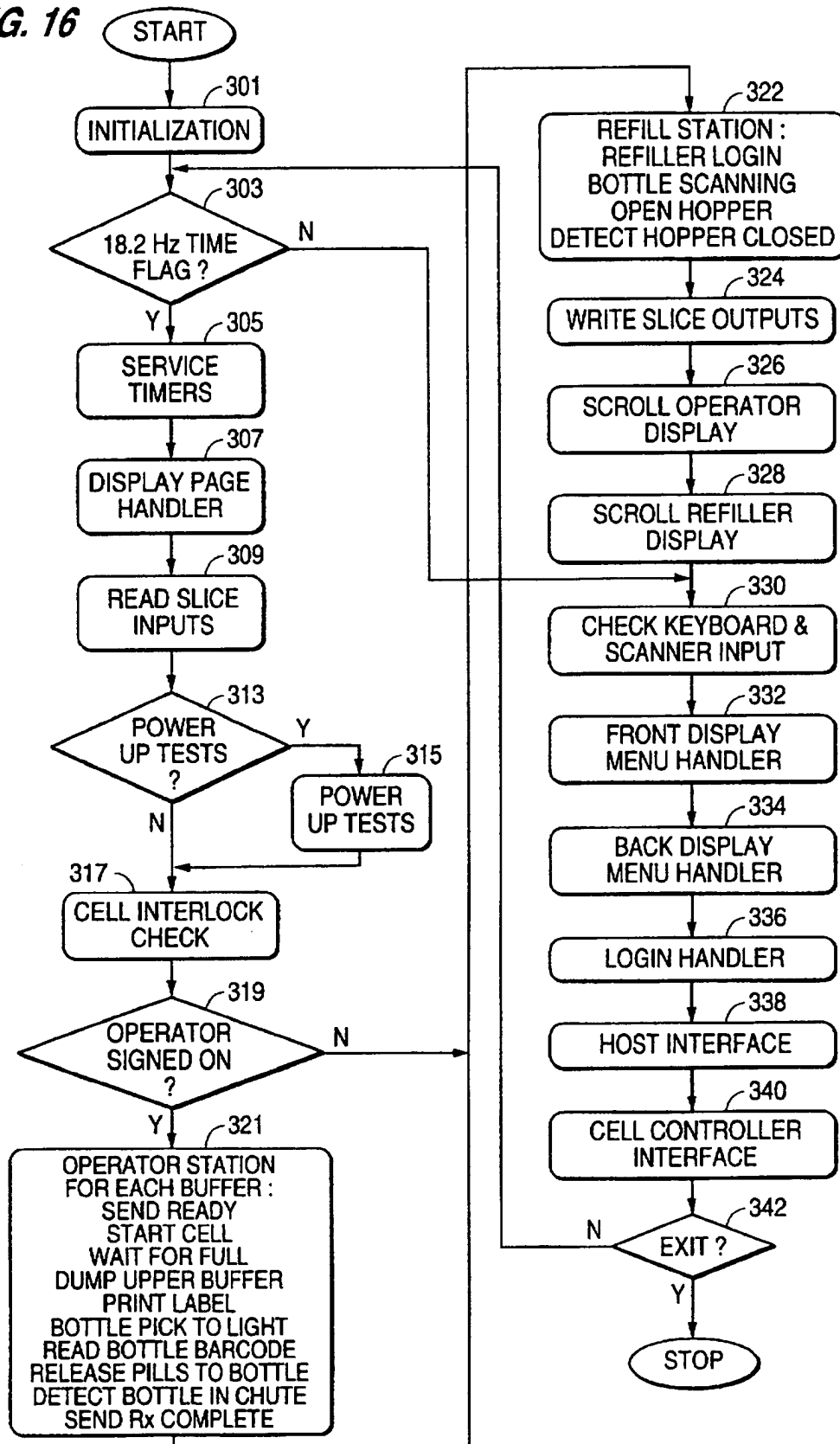
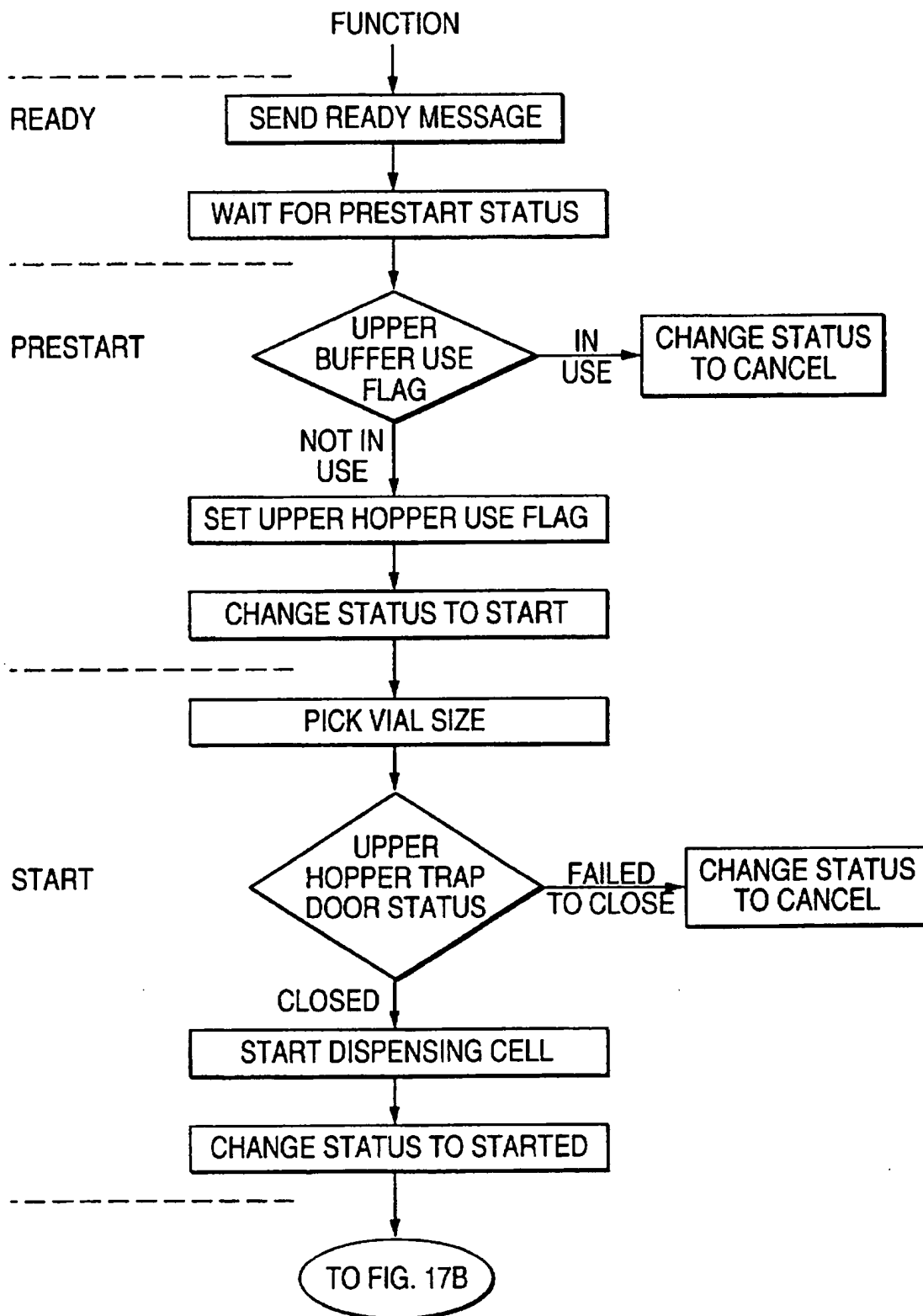


FIG. 17A



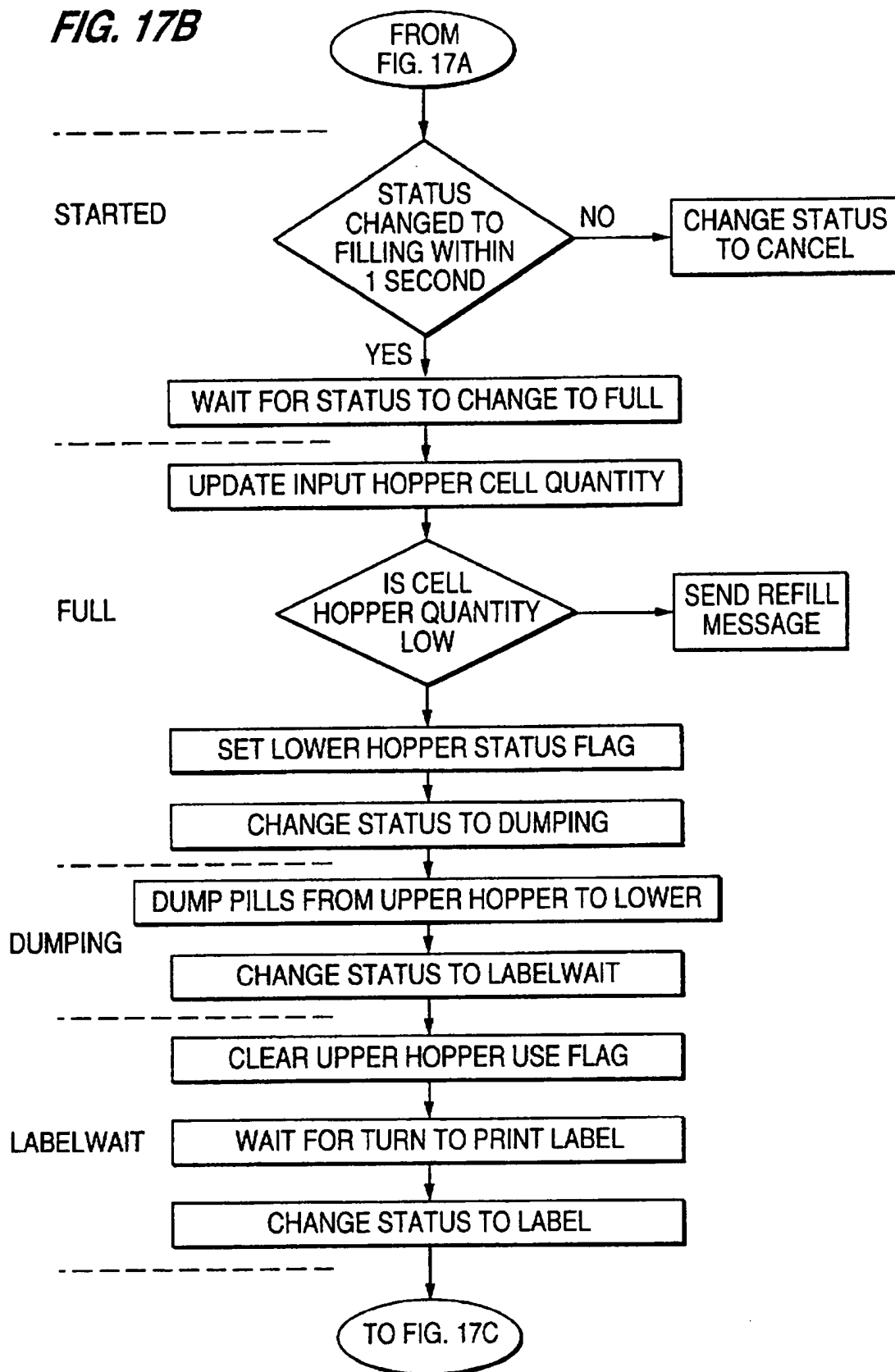
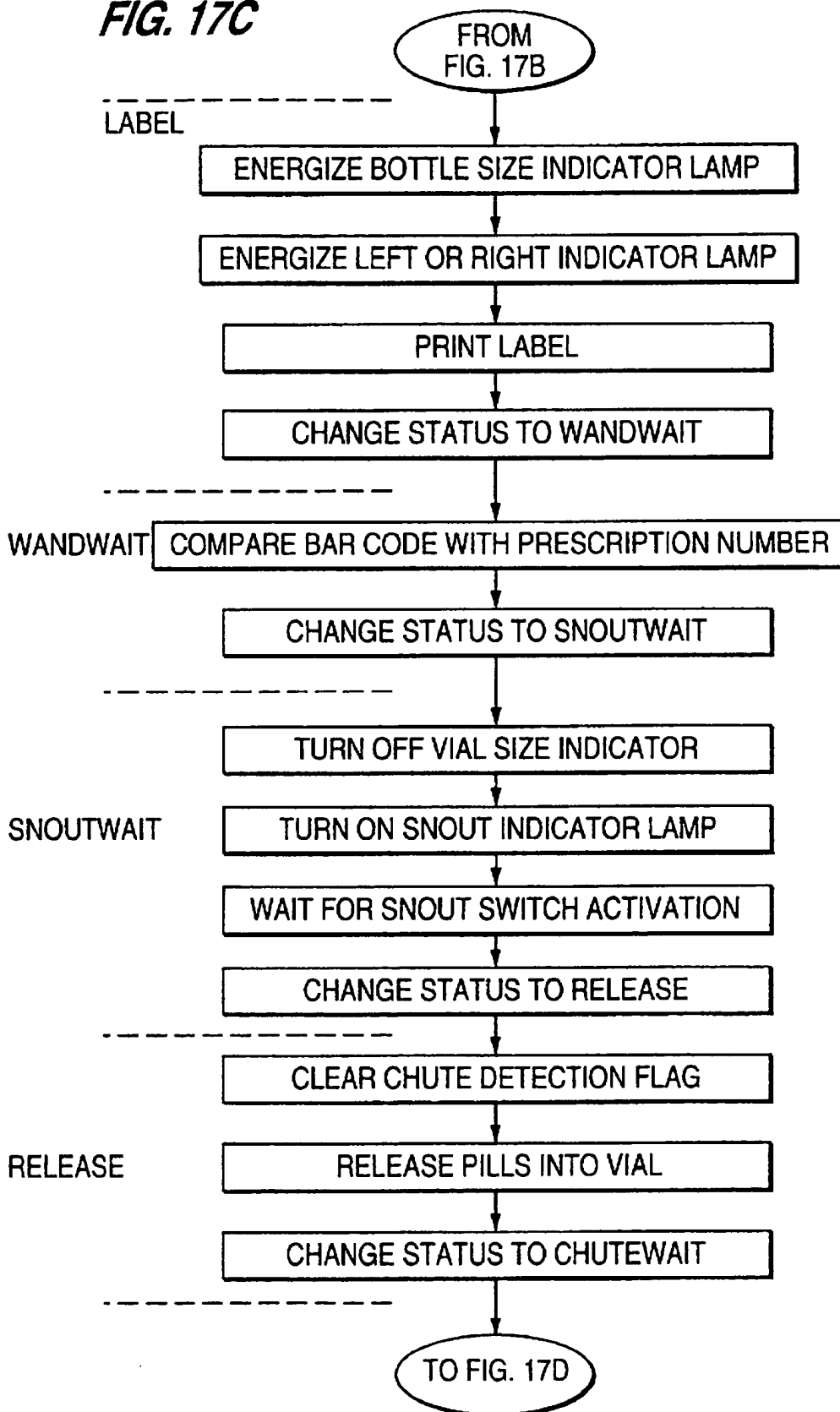
**FIG. 17B**



FIG. 17C





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FIG. 17D

